



Investigation of subcooled and saturated boiling heat transfer mechanisms, instabilities, and transient flow regime maps for large length-to-diameter ratio micro-channel heat sinks



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ABSTRACT

This study investigates the interfacial behavior and heat transfer mechanisms associated with flow boiling of R-134a in a micro-channel test module. The test module features 100 of $1 \times 1 \text{ mm}^2$ square micro-channels. Large length of micro-channels used (609.6 mm) is especially important to capturing broad axial variations of both flow and heat transfer behavior. The fluid is supplied to the test module in subcooled state to enable assessment of both the subcooled boiling and saturated boiling regions. The study employs a combination of temperature measurements along the test module and high-speed video to explore crucial details of the flow, including dominant flow regimes, flow instabilities, and downstream dryout effects. It is shown that, unlike macro-channel flows, where flow regimes can be clearly demarcated, flow regimes in micro-channels are associated with transient fluctuations that are induced by flow instabilities. The dominant flow behavior and associated dryout effects are characterized with the aid of a new transient flow regime map and a dryout map, respectively. Two sub-regions of the subcooled boiling region, partially developed boiling (PDB) and fully developed boiling (FDB), are examined relative to dominant interfacial and heat transfer mechanisms, and a previous correlation is identified for accurate prediction of the heat transfer coefficient for both PDB and FDB. The saturated boiling region is shown to consist of three separate sub-regions: nucleate boiling dominated for qualities below 0.3, combined nucleate and convective boiling for qualities between 0.3 and 0.5, and convective boiling dominated for qualities above 0.5. Above 0.5, dryout effects begin to take effect, causing a gradual decline in the heat transfer coefficient followed downstream by a more severe decline. A previous correlation is identified for prediction of the heat transfer coefficient in the saturated boiling region.

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1. Introduction

1.1. Two-phase cooling potential and features of two-phase mini/micro-channel cooling

Rapid escalation in heat dissipation in modern electronics and power applications, coupled with a quest for smaller and more lightweight packaging, has created a pressing need for more effective cooling solutions. Despite many innovative improvements to both air and single-phase liquid cooling, these cooling schemes have largely fallen short of maintaining acceptable device temperatures. These shortcomings have shifted interest among thermal system designers to two-phase cooling schemes, which capitalize

on the coolant's both sensible and latent heat to greatly enhance cooling performance compared to single-phase cooling schemes [1].

Over the past three decades, investigators at the Purdue University Boiling and Two-Phase Flow Laboratory (PU-BTPFL) and several other researcher groups have examined a broad variety of two-phase cooling solutions, the most basic of which are capillary-driven devices (heat pipes, capillary pumped loops, and loop heat pipes) [2–4] and pool boiling thermosyphons [5–7]. For applications demanding more superior cooling performance, a variety of pump-driven schemes have also been proposed, including falling film [8,9], channel flow boiling [10,11], mini/micro-channel flow boiling [12–15], jet-impingement [16–19], and spray [20–26].

Of the different two-phase cooling schemes, those employing mini/micro-channel cooling have received particular attention because of a number of thermal and system attributes. Their key

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